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## **BIB DATA SHEET**

## **CONFIRMATION NO. 1262**

10/718,549  11/24/2003  RULE  APPLICANTS Shinji Ohuchi, Tokyo, JAPAN; Yasushi Shiraishi, Tokyo, JAPAN; ************************************	SERIAL NUM			(c)	CLASS	GROUP ART	ROUP ART UNIT		ATTORNEY DOCKET	
APPLICANTS Shinji Ohuchi, Tokyo, JAPAN; Yasushi Shiraishi, Tokyo, JAPAN; Yasushi Shiraishi, Tokyo, JAPAN; ***CONTINUING DATA***********************************	10/718,54	9	<b>DATE</b> 11/24/2003		257	2814	2814		<b>NO.</b> OKI.136D3	
Shinji Ohuchi, Tokyo, JAPAN; Yasushi Shiraishi, Tokyo, JAPAN; ***CONTINUING DATA***********************************			RULE							
This application is a DIV of 10/386,490 03/13/2003 PAT 6,680,535 which is a DIV of 10/235,494 09/06/2002 PAT 6,613,694 which is a DIV of 09/460,987 12/15/1999 PAT 6,476,501  **FOREIGN APPLICATIONS ************************************	Shinji Ohuchi, Tokyo, JAPAN;									
JAPAN 102599/99 04/09/1999  ** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 02/18/2004  Foreign Priority claimed	which is a DIV of 10/235,494 09/06/2002 PAT 6,613,694									
FILING FEE RECEIVED 770 Integral To Charge/credit DEPOSIT ACCOUNT No for following:    O2/18/2004   Foreign Priority claimed										
35 USC 119(a-d) conditions met 2 Yes \( \text{No} \) No \( \text{Piffied and Acknowledged} \) No \( Piffied and A	** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 02/18/2004									
Verified and Acknowledged	,									
VOLENTINE & WHITT PLLC ONE FREEDOM SQUARE 11951 FREEDOM DRIVE SUITE 1260 RESTON, VA 20190 UNITED STATES  TITLE  Semiconductor device, manufacturing method for semiconductor device and mounting method for the same  FILING FEE RECEIVED 770  FEES: Authority has been given in Paper No		ied and /THAO X LE/		JAPAN	12	8		1		
ONE FREEDOM SQUARE 11951 FREEDOM DRIVE SUITE 1260 RESTON, VA 20190 UNITED STATES  TITLE  Semiconductor device, manufacturing method for semiconductor device and mounting method for the same  FILING FEE RECEIVED 770  FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:  Quality Suits and mounting method for the same  All Fees Quality 1.16 Fees (Filing) Quality 1.17 Fees (Processing Ext. of time) Quality 1.18 Fees (Issue)	ADDRESS									
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